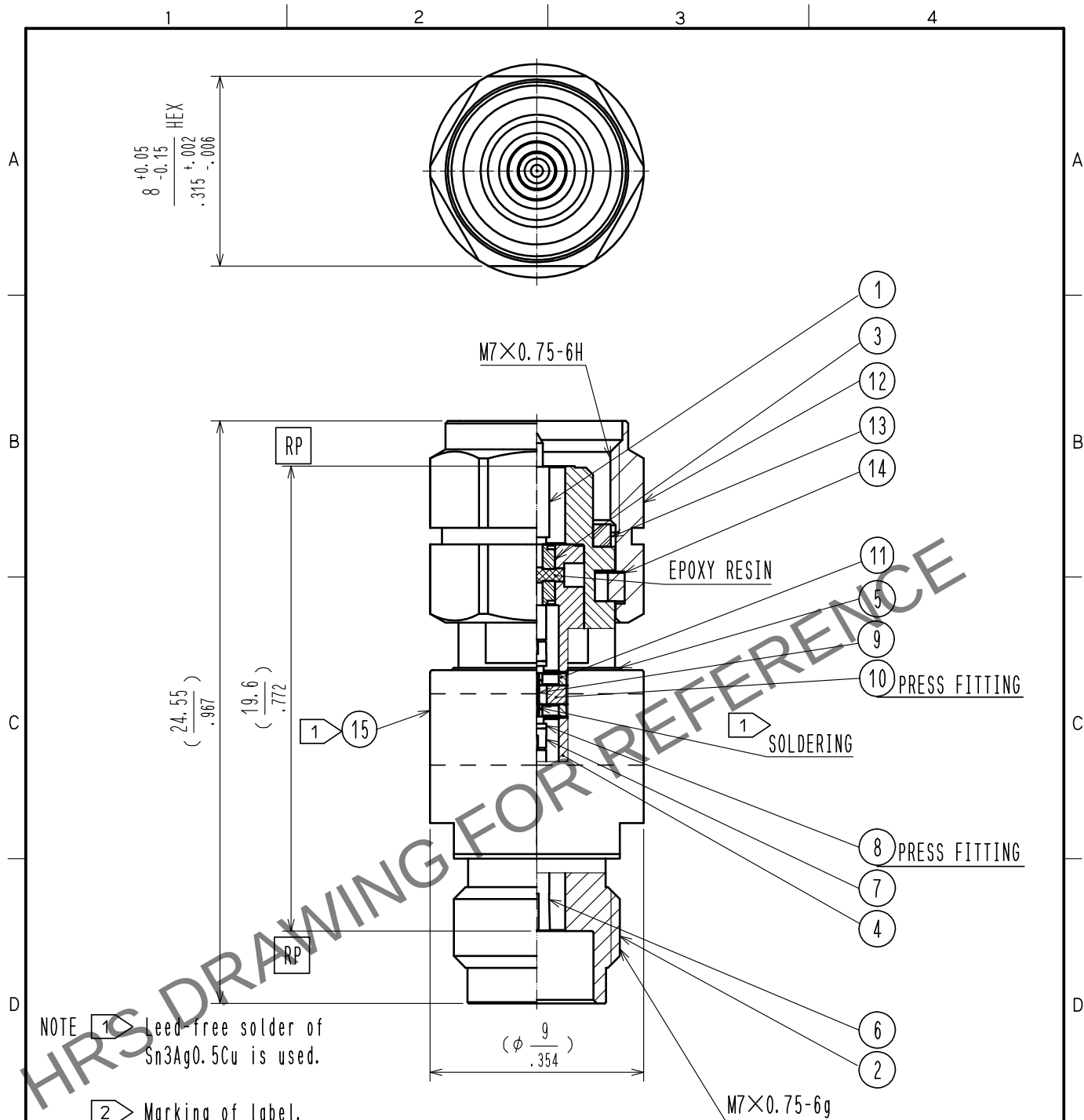




NOTE 1 Lead-free solder of Sn3Ag0.5Cu is used.

- 2 Marking of label.
1. Part No. H2.4-AT(1)-PJ
2. Production No.
3. Manufacturer abbreviation.

RoHS COMPLIANT

8	BRASS	GOLD PLATING			
7	BERYLLIUM COPPER	GOLD PLATING	15		LABEL
6	STAINLESS STEEL	PASSIVATE	14	BERYLLIUM COPPER	NICKEL PLATING
5	STAINLESS STEEL	PASSIVATE	13	SILICON RUBBER	
4	STAINLESS STEEL	GOLD PLATING	12	STAINLESS STEEL	PASSIVATE
3	PTFE		11	ALUMINIUM	
2	BERYLLIUM COPPER	GOLD PLATING	10	BRASS	GOLD PLATING
1	BRASS	GOLD PLATING	9	ALUMINA	

NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS
UNITS mm		SCALE 4 : 1		COUNT		DESCRIPTION OF REVISIONS	
DESIGNED		CHECKED		DATE			
APPROVED : TS. NOBE		18. 07. 10		DRAWING NO.		EDC-384089-00-00	
CHECKED : MH. OGUSU		18. 07. 10		PART NO.		H2. 4-AT(1)-PJ	
DESIGNED : HA. NISHIMURA		18. 07. 10		CODE NO.		CL354-0309-0-00	
DRAWN : HA. NISHIMURA		18. 07. 10					